

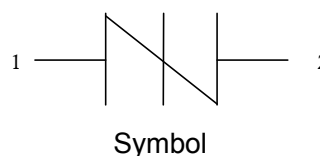


DESCRIPTION:

The sidac is a silicon bilateral voltage triggered switch with greater power-handling capabilities than standard diacs. Upon application of a voltage exceeding the sidac breakover voltage point, the sidac switches on through a negative resistance region to a low on-state voltage. Conduction continues until the current is interrupted or drops below the minimum holding current of the device.

APPLICATIONS:

- ✧ High-voltage lamp ignitors
- ✧ Natural gas ignitors
- ✧ Gas oil ignitors
- ✧ High-voltage power supplies
- ✧ Xenon ignitors
- ✧ Overvoltage protector
- ✧ Pulse generators
- ✧ Fluorescent lighting ignitorsHID lighting ignitors



FEATURES:

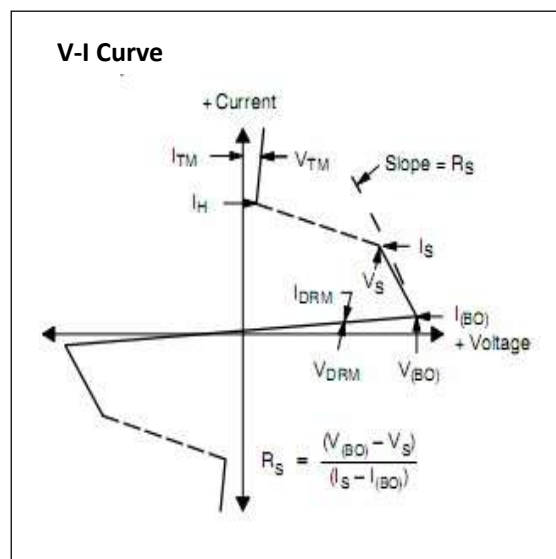
- ✧ Excellent capability of absorbing transient surge
- ✧ Quick response to surge voltage (ns Level)
- ✧ Glass-passivated junctions
- ✧ High voltage lcmp ignitors

ABSOLUTE MAXIMUM RATINGS ($T_A=25^{\circ}\text{C}$, RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
Storage temperature range	T_{stg}	-40 to +125	$^{\circ}\text{C}$
Operating junction temperature range	T_j	-40 to +125	$^{\circ}\text{C}$
On-state RMS Current	I_T	1	A
Maximum surge on-state current non-repetitive one cycle peak value (50Hz)	I_{TSM}	16.7	A
Critical rate-of-rise of on-state current	di_T/dt	80	A

ELECTRICAL CHARACTERISTICS ($T_A=25^{\circ}\text{C}$)

Symbol	Parameter
V_{DRM}	Peak off-state voltage
I_{DRM}	Off-state current
V_{S}	Switching voltage
I_{S}	Switching current
R_{S}	Switching resistance
V_{T}	On-state voltage
I_{H}	Holding current
V_{BO}	Breakover Voltage
I_{BO}	Breakover current

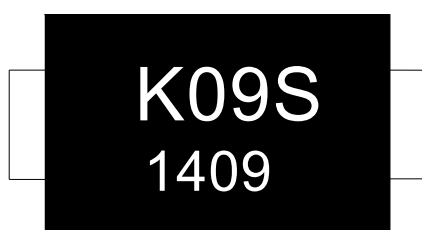
ELECTRICAL CHARACTERISTICS ($T_A=25^{\circ}\text{C}$, continued)

Part Number	$I_{\text{DRM}}@V_{\text{DRM}}$		V_{BO}		I_{BO}	$V_{\text{T}}@ I_{\text{T}}=1\text{A}$	I_{H}	R_{S}	Marking
	μA	V	V		μA	V	mA	$\text{k}\Omega$	
	max	min	min	max	max	max	min	min	
K0900S	1	70	80	97	50	2	10	0.1	K09S
K1050S	1	90	95	113	50	2	10	0.1	K10S
K1200S	1	100	110	125	50	2	10	0.1	K12S
K1300S	1	110	120	138	50	2	10	0.1	K13S
K1400S	1	120	130	146	50	2	10	0.1	K14S
K1500S	1	130	140	170	50	2	10	0.1	K15S
K1800S	1	160	170	195	50	2	10	0.1	K18S
K2000S	1	180	190	215	50	2	10	0.1	K20S
K2200S	1	190	205	230	50	2	10	0.1	K22S
K2400S	1	200	220	250	50	2	10	0.1	K24S
K2600S	1	220	240	270	50	2	10	0.1	K26S

ORDERING INFORMATION

K	090	0	S
Series code K:Sidac	Median voltage	0: Bi-direction 1: Uni-direction	Package type:Surface mount

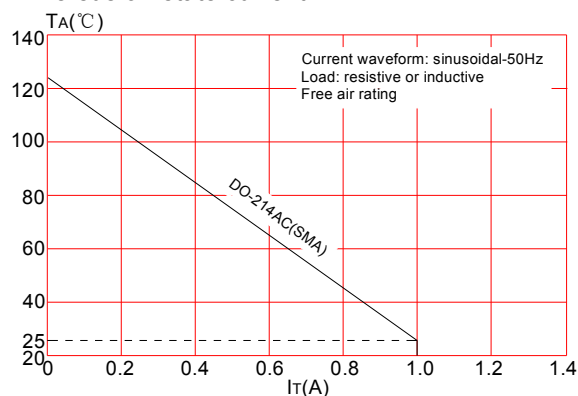
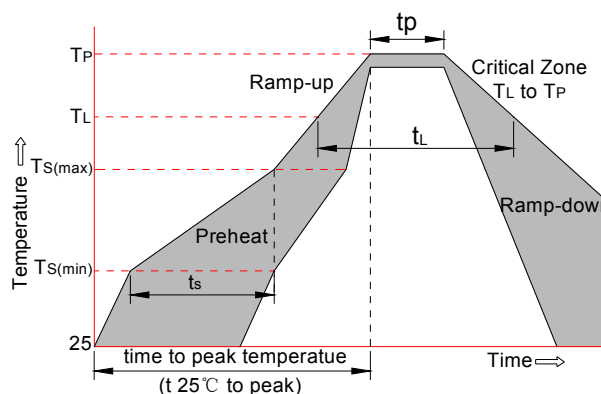
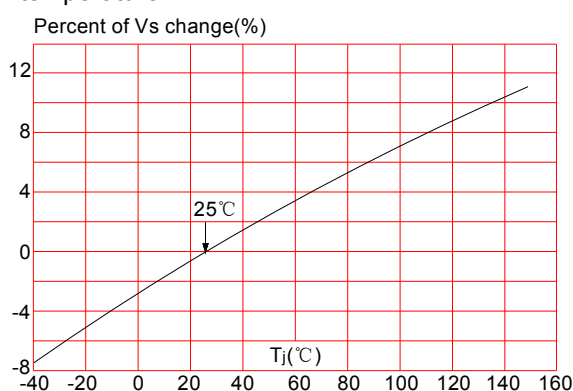
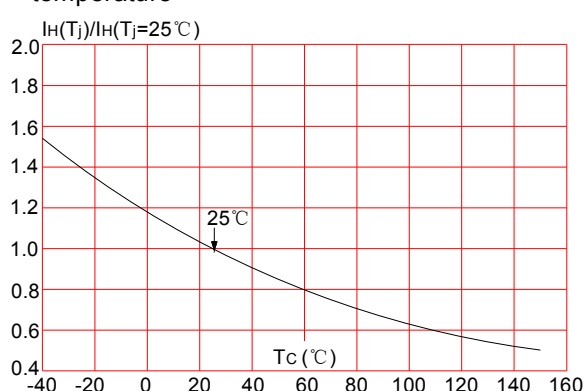
MARKING



K09S:Device Marking Code
1409: In ninth week, 2014

SOLDERING PARAMETERS

Reflow Condition		Pb-Free assembly (see FIG.2)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150°C
	-Temperature Max($T_{s(max)}$)	+200°C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3°C/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature(T_L) (Liquid us)	+217°C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		8-15 secs.
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T_P)		8 min. Max
Do not exceed		+260°C

FIG.1: Maximum allowable ambient temperature versus on-state current**FIG.2:** Reflow condition**FIG.3:** Normalized Vs change vs. junction temperature**FIG.4:** Normalized DC holding current vs. case temperature

TAPE AND REEL SPECIFICATION

PACKAGE	REEL (PCS)	PER CARTON (PCS)	REEL DIAMETERS (mm)
DO214AC/SMA	5,000	80,000	330
DO214AA/SMB	3,000	48,000	330

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